



WMAS4R7A

4.7T ROOM TEMP SUPERCONDUCTOR-LIKE PREAMPLIFIER

REV B

October 2023

Key Features



- For 50 Ohm Source Impedance
- 4.7T Frequency of 200 MHz
- 1.5 Ohm Input Impedance
- **0.23 dB Noise Figure**
- 35.0 dBm Max P_{IN}
- 22.0 dBm Output IP_3
- 28.0 dB Gain @ $Z_s = 50 \Omega$
- 10.0 dBm Output P_{1dB}
- 1.22:1 Output VSWR
- Unconditional Stable, $k > 1$
- Single Power Supply
- Non Magnetic

Product Description

With its low input impedance, WMAS4R7A is a room temperature superconductor-like MRI preamplifier (preamp) for multi-channel coil applications. Due to its large equal noise circles, the preamp maintains excellent noise figure over wide source impedance variation that either comes from the different coil loads or non-ideal design implementation of the coils. Moreover, the preamp allows higher source impedance design to increase the blocking impedance while maintaining superior SNR. The amplifier has 0.60" x 0.40" x 0.10" surface mount package.



Applications

- Magnetic Resonance Imaging
- RF Measurement
- Medical
- Current Sensor



Specifications

Other frequencies and impedance available!

Summary of the key electrical specifications at room temperature of 21 °C, tested in the WanTcom fixture, 80051.

Item	Test Parameter	Symbol	Test Constraint	Min	Nom	Max	Unit
1	Gain	S_{21}	200 MHz, $Z_s = 50 \Omega$	27.5	28.0	28.5	dB
2	Gain Variation	ΔG	200 +/- 1 MHz		+/-0.05	+/- 0.1	dB
3	Input Impedance	RE [Zin]	200 MHz	1.0	1.5	2.0	Ohm
		IM [Zin]	200 MHz, with 80051, which has 0.085 pS electrical length @ input port	-2.0	0	2.0	Ohm
4	Output VSWR, $Z_s = 50 \Omega$	SWR_2	200 MHz			1.22:1	Ratio
5	Reverse Isolation	S_{12}	200 MHz	60	70		dB
6	Noise Figure	NF	200 MHz, $Z_s = 50 \Omega$, -6 dB pad method ¹		0.23	0.40	dB
7	Output 1dB Gain Compression Point	P_{1dB}	200 MHz	8	10		dBm
8	Output-Third-Order Interception Point	IP_3	Two-Tone, $P_{out} = -5$ dBm each, 1 MHz separation	18	22		dBm
9	DC Current Consumption	I_{dd}	$V_{dd} = +10.0$ V		17		mA
10	DC Power Supply Operating Voltage	V_{dd}		+7	+10	+12	V
11	Thermal Resistance	$R_{th,c}$	Junction to case			215	°C/W
12	Operating Temperature	T_o		+10		+60	°C
13	Maximum RF Input Power	$P_{IN,MAX}$	200 MHz, 6% Duty Cycle, $Z_s = 50$ Ohm			35	dBm
14	Saturate Recover Time	t_{sr}	10% to 90% from 20 dBm Pin, $Z_s = 50$ Ohm		2	4	uS
15	ESD Protection, None Contact	V_{ESDN}	Output Port			18	kV
16	ESD Protection, Direct Contact	V_{ESD}	Output Port			8	kV

Absolute Maximum Ratings

Parameter	Unit	Rating
DC Power Supply Voltage	V	-0.5/15.0
Drain Current	mA	30
Total Power Dissipation	mW	350
RF Input Power, 6% Duty Cycle	dBm	35
Junction Temperature	°C	150
Storage Temperature	°C	-40 ~ 125
Operating Temperature	°C	0 ~ +70
Thermal Resistance ²	°C/W	215

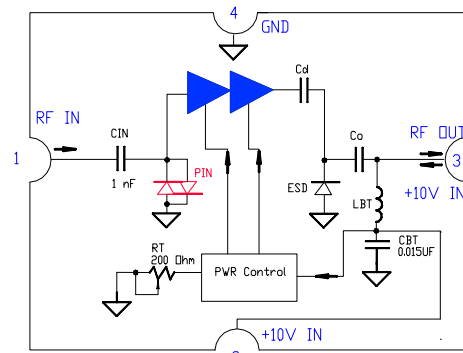
Operation of this device beyond any one of these parameters may cause permanent damage.

¹ Refers to AN-154, AN-106.

² The last stage transistor dominates the heat dissipation. The drain bias voltage is +6V and the drain current is 12.0 mA. The total power dissipation of the last stage transistor is thus 72 mW. The junction temperature arise $0.072 \times 215 = 16$ (°C).

Specifications and information are subject to change without notice.

Functional Block Diagram



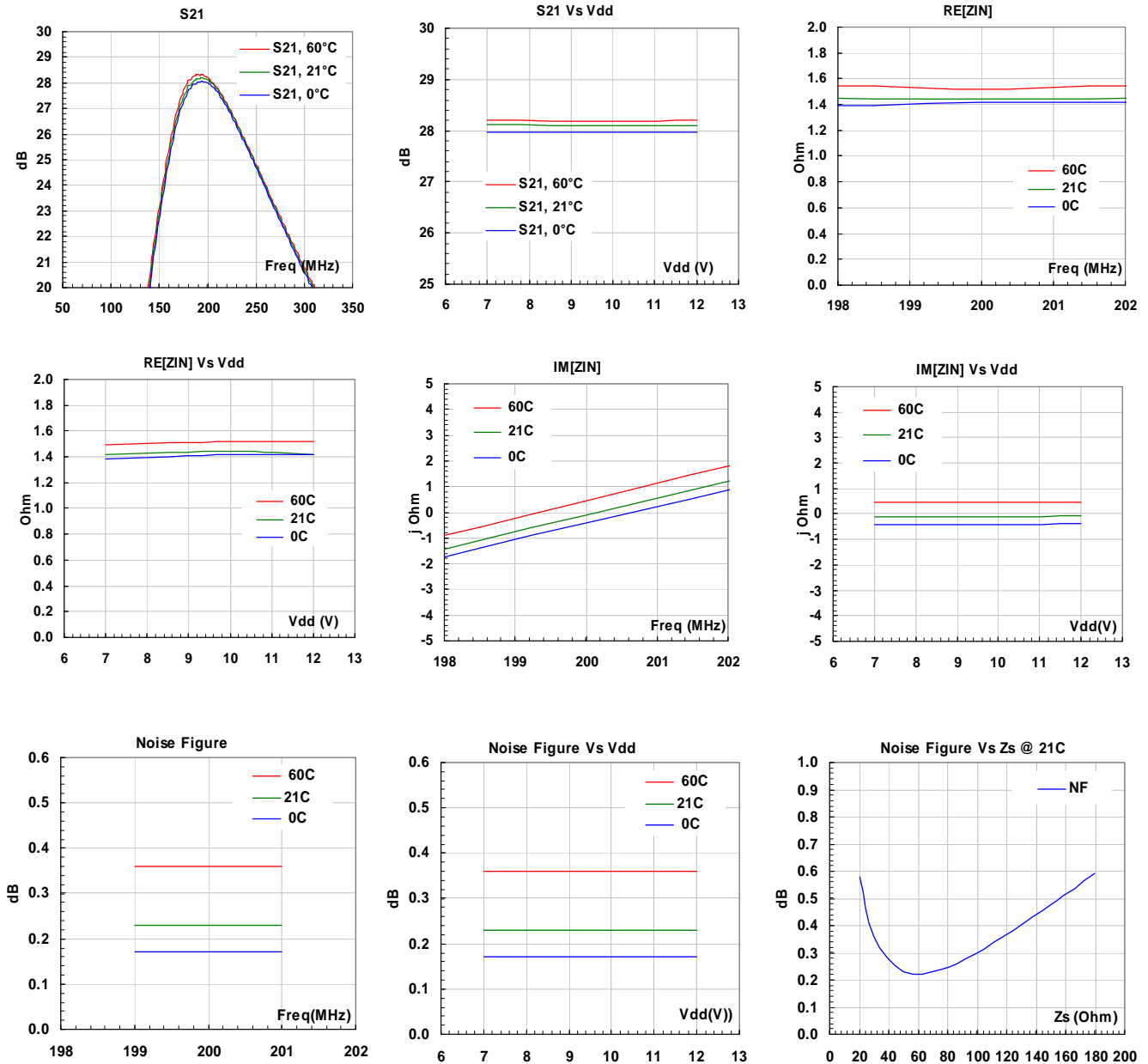


Ordering Information

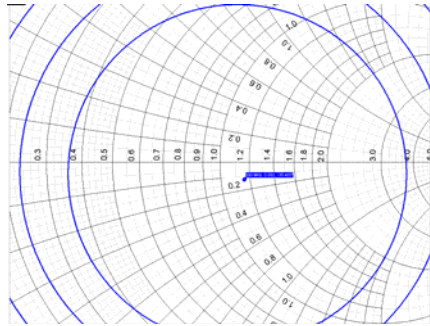
Model Number	WMAS4R7A
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10 x 10 ESD Tray is used for the packing. Contact factory for other packing options.

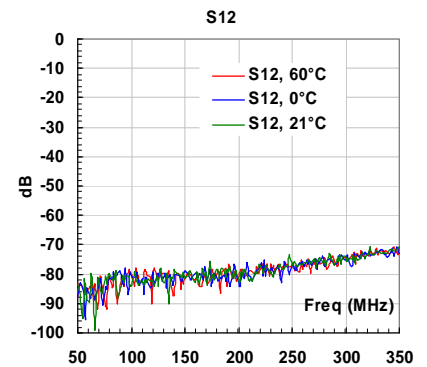
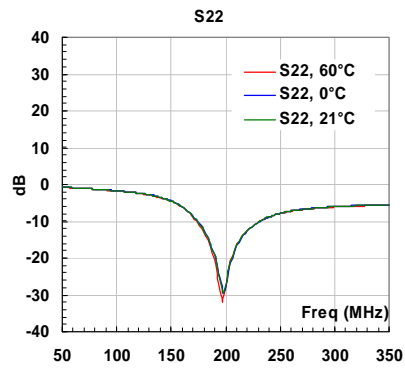
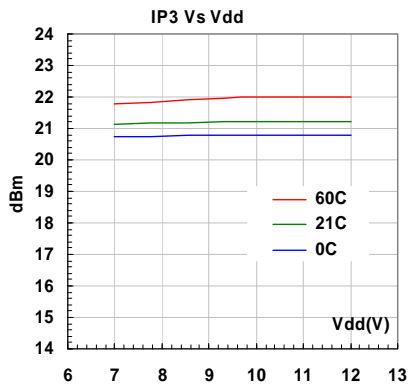
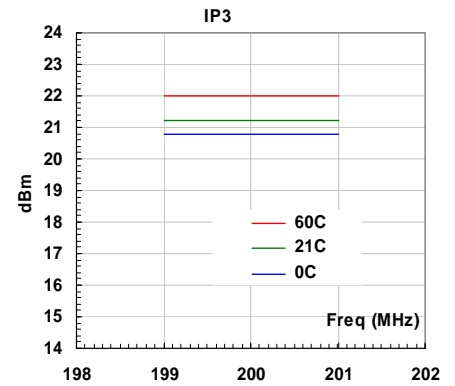
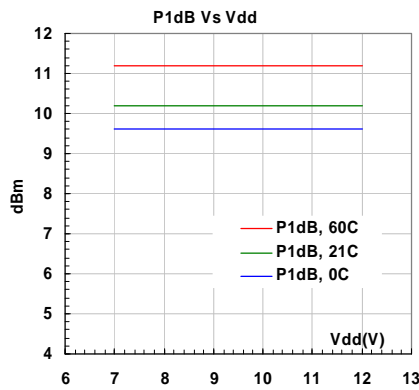
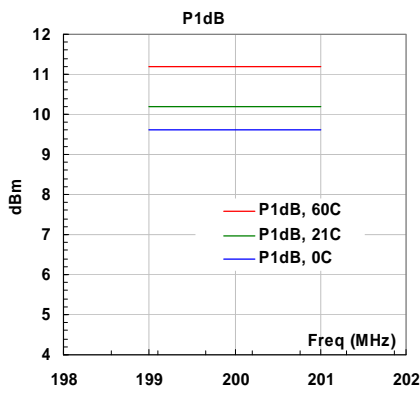
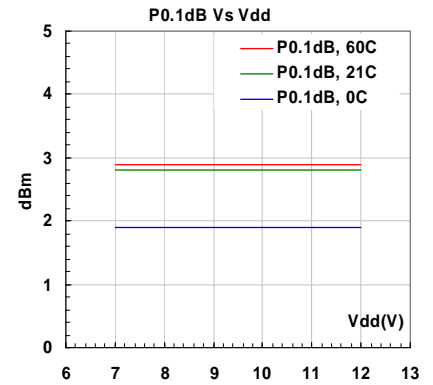
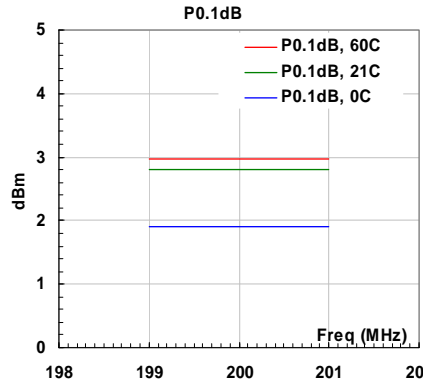
Typical Performance Data



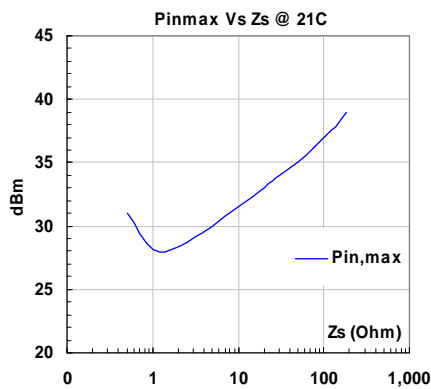
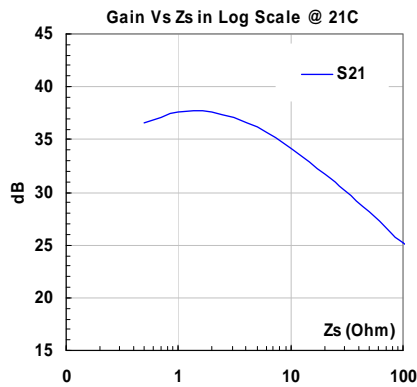
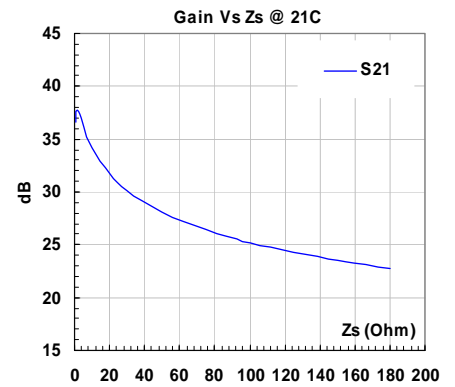
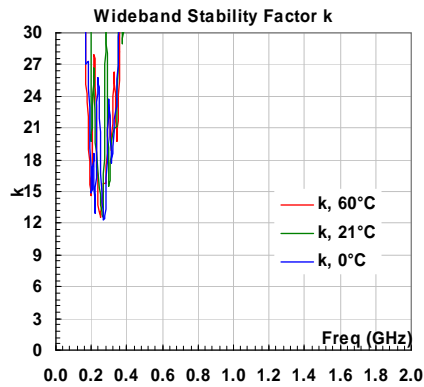
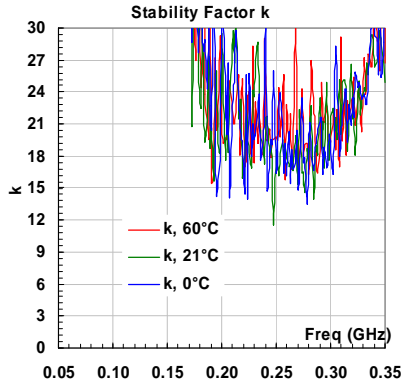
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Noise Circles



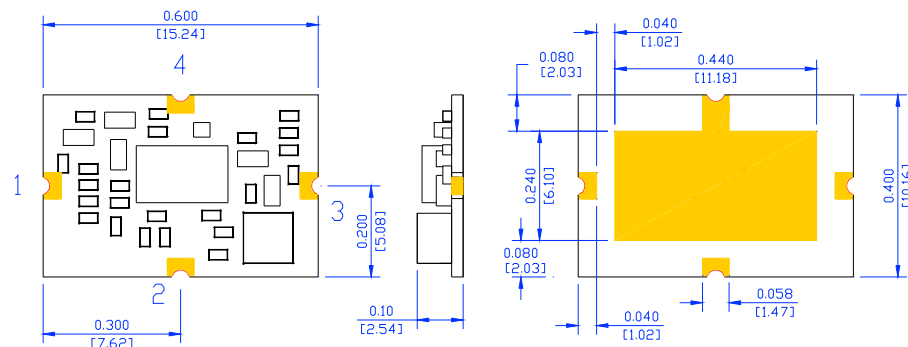
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Outline,

PIN	1	2	3	4	CNTR
FCTN	IN	NC/10V	OUT/10V	GND	GND

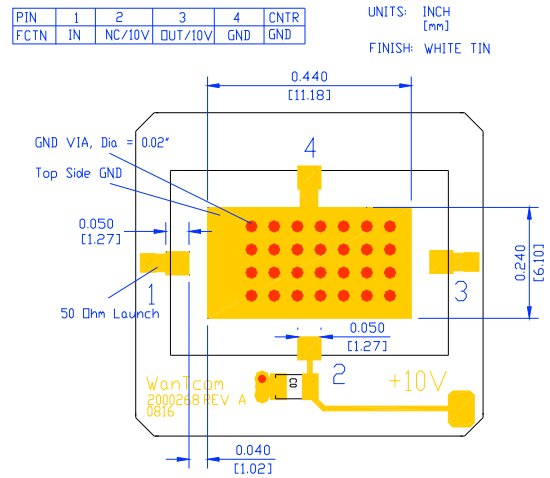
UNITS: INCH [mm]
FINISH: WHITE TIN



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Foot Print/Mounting Layout



Application Notes:

A. Motherboard Layout

The recommended motherboard layout is shown in the diagram of **Foot Print/Mounting Layout**. Sufficient quantities of ground vias on center ground paddle are essential for the RF grounding. The width of the 50-Ohm microstrip lines at the input and output RF ports may be different for different property of the substrate. The ground plane on the backside of the substrate is needed to insure the isolation between the center ground paddle through the vias. The ground plane is also essential for the 50-Ohm microstrip line launches at the input and output ports.

In order to have stable preamp in the coil system, the minimum system isolation of 55 dB between the input and output soldering pads for the preamp with all the feed board components including the coils on the feed board is required. Poor system isolation can introduce possible external feedback either in pass band or off band and cause the preamp having parasitic oscillation. Measuring the S_{12} or S_{21} between the input and output pads without the installation of the preamp is essential to insure the isolation is better than 55 dB. Shorter output path or even shielded output circuitry is recommended for better isolation.

The +10V DC voltage can be applied at Pin 2 or at the output Pin 3. There is a built-in bias-T at the output port to separate the RF output signal and the input +10V DC power supply. Pin 2 and Pin 3 are DC connected internally which has 120 mA maximum DC current rating between the 2 ports.

No DC block capacitor is required at input port.

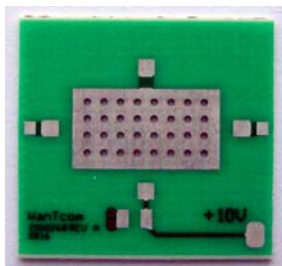


Fig. 1 Example of the test board

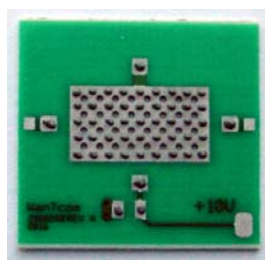


Fig. 2 Dispensed solder paste

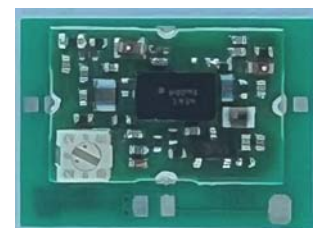


Fig. 3 Assembled preamp

Specifications and information are subject to change without notice.



B. Assembly

The high temperature solder is used internally center chip assembly. The melting temperature point of the high temperature solder is around 240 °C. Thus, melting temperature of the solder paste should be way below 240 °C for assembling the pre-amp on the test board or feed board.

For high reliability product, RoHS 40Bi/60SN solder paste, which melting temperature point being around 180 °C, is recommended for the assembly purpose.

For RoHS requirement, Bismuth based Lead free solder paste such as 60Sn/40Bi is suitable for the assembly.

Warning: regular SAC305 RoHS reflow process will damage the pre-amp!

The solder paste can be dispensed by a needle manually or driven by a compressed air. **Figure 2** shows the example of the dispensed solder paste pattern. Each solder paste dot is in the diameter of 0.005" ~ 0.010" (0.125 ~ 0.250 mm).

For volume assembly, a stencil with 0.006" (0.15 mm) is recommended to print the solder paste on the circuit board.

For more detail assembly process, refer to AN-109 at www.wantcominc.com website.

C. Input Protection

Even though there is a built-in cross diodes, the preamp cannot survive beyond 35 dBm transmitting (TX) power at 50 Ohm source impedance. The maximum input power, Pinmax, is different at the different source impedance. The lowest Pinmax happens at the Z_s being around 1 to 2 Ohm, refers to the last curve in page 4. Thus, increase the source impedance during the TX cycle is better than lower the impedance from preamp protection point of view.

Additional protection such as coil detuning and coarse limiter are needed depending on the TX power and special isolation between the TX coil and receiving coils.

D. Dog-Ears Effect

The gain goes higher as Z_s decreases and peaks at around 1 ~ 2 Ohm (conjugate matching between the source and preamp). Due to Z_s (designed to be 50 Ohm at MRI frequency) are around 1.5 Ohm at upper and lower sides frequencies by the MRI frequency, the dual gain peaks occur, so called Dog-Ears effect. The gain peaks can be around 10 dB higher than that at the MRI frequency. It has been a challenge to coil designers to keep the preamp stable for decades since using low input impedance preamps. Thus, the feed board layout for good isolation of minimum 55 dB is critical to prevent the oscillation at the Dog-Ears frequencies.

E. Source Impedance Selection

The noise figure is below 0.30 dB at the source impedance, Z_s , range from 40 to 80 Ohm. The optimum noise figure of 0.22 dB happens around $Z_s = 60$ Ohm while the gain is still over 26 dB. The higher the source impedance, the higher the coil blocking impedance and the wider span of the Dog-Ears frequencies will be achieved.
